Microbeam analysis — Electron probe microanalysis — Quantitative point analysis for bulk specimens using wavelength dispersive X-ray spectroscopy

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Foreword

ISO (the International Organization for Standardization) is a worldwide federation of national standards bodies (ISO member bodies). The work of preparing International Standards is normally carried out through ISO technical committees. Each member body interested in a subject for which a technical committee has been established has the right to be represented on that committee. International organizations, governmental and non-governmental, in liaison with ISO, also take part in the work. ISO collaborates closely with the International Electrotechnical Commission (IEC) on all matters of electrotechnical standardization.

The procedures used to develop this document and those intended for its further maintenance are described in the ISO/IEC Directives, Part 1. In particular the different approval criteria needed for the different types of ISO documents should be noted. This document was drafted in accordance with the editorial rules of the ISO/IEC Directives, Part 2 (see www.iso.org/directives).

Attention is drawn to the possibility that some of the elements of this document may be the subject of patent rights. ISO shall not be held responsible for identifying any or all such patent rights. Details of any patent rights identified during the development of the document will be in the Introduction and/or on the ISO list of patent declarations received (see www.iso.org/patents).

Any trade name used in this document is information given for the convenience of users and does not constitute an endorsement.

For an explanation on the meaning of ISO specific terms and expressions related to conformity assessment, as well as information about ISO’s adherence to the World Trade Organization (WTO) principles in the Technical Barriers to Trade (TBT) see the following URL: www.iso.org/iso/foreword.html.

The committee responsible for this document is ISO/TC 202, Microbeam analysis, Subcommittee SC 2, Electron probe microanalysis.

This second edition cancels and replaces the first edition (ISO 22489:2006), of which it constitutes a minor revision to update the references and to revise text in 4.4.1 and 4.4.8.
Introduction

Electron probe microanalysis is widely used for the quantitative analysis of elemental composition in materials. It is a typical instrumental analysis and the electron probe microanalyser has been greatly improved to be user friendly. Obtaining accurate results with this powerful tool requires that it be properly used. In order to obtain reliable data, however, optimum procedures must be followed. These procedures, such as preparation of specimens, measurement of intensities of characteristic X-rays and calculations of concentrations calculated from X-ray intensities, are given for use as standard procedures in this International Standard.
Microbeam analysis — Electron probe microanalysis — Quantitative point analysis for bulk specimens using wavelength dispersive X-ray spectroscopy

1 Scope

This International Standard specifies requirements for the quantification of elements in a micrometre-sized volume of a specimen identified through analysis of the X-rays generated by an electron beam using a wavelength dispersive spectrometer (WDS) fitted either to an electron probe microanalyser or to a scanning electron microscope (SEM).

This International Standard also describes the following:

— the principle of the quantitative analysis;
— the general coverage of this technique in terms of elements, mass fractions and reference specimens;
— the general requirements for the instrument;
— the fundamental procedures involved such as specimen preparation, selection of experimental conditions, the measurements, the analysis of these and the report.

This International Standard is intended for the quantitative analysis of a flat and homogeneous bulk specimen using a normal incidence beam. It does not specify detailed requirements for either the instruments or the data reduction software. Operators should obtain information such as installation conditions, detailed procedures for operation and specification of the instrument from the makers of any products used.

2 Normative references

The following documents, in whole or in part, are normatively referenced in this document and are indispensable for its application. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

ISO 14594, Microbeam analysis — Electron probe microanalysis — Guidelines for the determination of experimental parameters for wavelength dispersive spectroscopy

ISO 14595, Microbeam analysis — Electron probe microanalysis — Guidelines for the specification of certified reference materials (CRMs)

ISO/IEC 17025:2005, General requirements for the competence of testing and calibration laboratories

3 Abbreviated terms

EPMA  electron probe microanalyser
SEM  scanning electron microscope
EDS  energy dispersive spectrometer
PHA  pulse height analyser
P/B  peak-to-background ratio
4 Procedure for quantification

4.1 General procedure for quantitative microanalysis

4.1.1 Principle and procedure of quantitative microanalysis

The characteristic X-ray intensities from electron beam interactions with a solid are approximately proportional to the mass fraction of the elements contained within the interaction volume. By measurement of characteristic X-ray intensities, the mass fractions of the elements that compose a specimen can be determined.

Quantitative analysis is performed by comparing the intensity of a characteristic X-ray line of an element in the specimen with that from a reference material containing a known mass fraction of the element, the measurements being performed under identical experimental conditions. The relationship between intensity and mass fraction is not linear over a wide mass fraction range; correction calculations for both specimen and reference material are therefore required.

X-ray absorption within the specimen and the reference material results in the emitted intensities being less than the generated intensities; therefore, a correction is made for this. A correction is also made for characteristic X-ray fluorescence in the analytical volume, and the effect of loss of X-ray production due to electron backscattering. When electrons enter the specimen, they lose energy due to the interactions with the constituent atoms. As well as being dependent on electron energy, the rate of energy loss is a function of the mean atomic number. The matrix correction procedure, thus, has three components, corresponding to the atomic number ($Z$), the absorption ($A$), and the characteristic fluorescence ($F$).

The accuracy of the quantitative analysis depends upon the selection of the reference materials, the specimen preparation process, the measurement conditions/method, the stability and calibration of the instrument, and the use of models for quantitative correction.

4.1.2 Coverage of the quantitative analysis

Reference materials and unknown specimens shall fulfil the following conditions:

— be stable under the action of the electron beam and stable in vacuum;
— have a flat surface perpendicular to the electron beam;
— be homogenous over the analysis volume;
— have no magnetic domains.

For the analysis volume, see ISO 14594 (analysis area and depth and volume).

It is possible to perform quantitative elemental analysis for elements with an atomic number greater than or equal to 4 (beryllium).

The detection limit for quantitative analysis depends on many parameters, such as the X-ray line selected, the matrix and the operating conditions (beam intensity, accelerating voltage and counting parameters). It varies from a few parts per million (ppm) to a few hundred ppm.

NOTE 1 Detection limits are covered in ISO 17470.

NOTE 2 For light-element analysis or strong X-ray absorption conditions, the detection limit may be above 1 % (i.e. B Kα in silicon matrix).

The accuracy obtainable is governed by the mass fraction of the element, the measurement conditions and the correction calculation. It is generally considered that the relative precision and relative accuracy for major elements can be better than 1 % and 2 %, respectively.

NOTE 3 For analysis of elements in a strongly absorbing matrix with a reference material not matched to the specimen in composition, accuracy may be significantly worse than 2 %.
4.1.3 Selection of reference materials

The reference materials shall be in accordance with the specifications of ISO 14595.

In general, pure elements are used, but corrections for matrix effects are minimized when the composition of the reference material is close to that of the unknown specimen.

When coating of the specimen is required (see 4.2), the reference material shall be coated under the same conditions.

4.2 Specimen preparation

The specimens (reference specimen and unknown specimen) shall be clean and free of dust.

The specimen surface shall be flat. If necessary, the specimen shall be embedded in a conducting medium and metallographically polished.

The specimen must have good electrical conductivity. Charging under electron beam irradiation can be avoided by coating the specimen with a very thin conductive layer of a suitable material. A conducting path shall be established between the specimen surface and the metallic specimen holder.

Carbon coating is generally used but, in particular cases (e.g. light-element analysis), other materials should be considered (Au, Al, etc.). Carbon to a thickness of about 20 nm can be used.

It is recommended that both the reference material and unknown specimen be coated with the same element at the same thickness.

4.3 Calibration of the instrument

4.3.1 Accelerating voltage

It is important to check that the accelerating voltage is correct for the quantitative analysis to be accurate.

Quantification errors will occur if the accelerating voltage is not known accurately and if it is not stable. The accelerating voltage shall therefore be calibrated and stable.

NOTE If an EDS system is attached to the EPMA, the true voltage may be determined through measurement of the Duane-Hunt limit. If an EDS system is not attached, there is no generally available calibration method. It is advisable to request that the manufacturer periodically checks the voltage values.

4.3.2 Probe current

Quantification errors will occur if the probe current is not known accurately and if its stability is low. The probe current shall therefore be accurately monitored and stable.

The probe current is normally measured using a Faraday cup.

4.3.3 X-ray spectrometer

It is necessary to confirm the accurate adjustment of the X-ray spectrometer prior to its use for measurement. This should be done for all spectrometers and all crystals by following the instructions given by the manufacturer of the instrument.

The proportionality of the X-ray detector shall be checked.

NOTE The proportionality of the X-ray detector is covered in ISO 14594.
4.3.4 Dead time

It is necessary to correct for the loss of X-ray counts due to the counting-chain dead time. A dead-time calibration curve shall be determined as specified in ISO 14594.

4.4 Analysis conditions

4.4.1 Accelerating voltage

The accelerating voltage, typically between 5 kV and 30 kV, shall be selected to meet the following criteria:

— the accelerating voltage shall exceed 1.5 times the critical ionization energy of the most energetic X-ray line used in the analysis;
— the volume to be analysed should be homogenous over a volume larger than that of the ionization volume;
— the accelerating voltage shall not be so high as to induce heat or electrostatic damage or make large absorption corrections necessary.

For every element, the measurements on the reference and unknown specimen should be performed at the same accelerating voltage. In particular cases, however, it is possible to carry out quantitative analysis using different accelerating voltages to optimize the X-ray intensities of elements in the same energy range.

4.4.2 Probe current

The probe current shall be selected to meet the following criteria:

— the X-ray intensity shall be high enough for an accurate result to be obtained;
— the X-ray intensity shall not be so high that it saturates the X-ray detector;
— contamination and thermal and electrostatic damage shall be minimized.

The stability of the probe current shall be checked before making a measurement.

Glasses and some minerals (e.g. plagioclases) contain alkali metals such as Na, K, etc., which migrate under a focused beam and they should therefore be analysed using a defocused beam.

4.4.3 Analysis position

If the instrument has an optical microscope, the feature requiring analysis should be positioned in the centre of the optical field and the height of the specimen adjusted until it is in focus. In addition, the operator shall ensure that the position of the probe is stable.

The focal point of the spectrometer shall be adjusted to be the same as the focal point of the optical microscope, at the centre of the optical microscope and the centre of the electron image.

With vertically mounted spectrometers, the spectrometer sensitivity falls rapidly if the specimen height is incorrect. Therefore, it is essential to use the instrument’s optical microscope because its small depth of focus ensures that, when a sharp image is obtained, the specimen is correctly positioned. With inclined spectrometers usually fitted to SEMs, the sensitivity is much less dependent upon vertical variations and it is sufficient to locate the specimen to within 100 μm.

In an SEM/WDS having no optical microscope, one can proceed as follows. First, select a place in the reference specimen (specimen holder) that is known to be at the focal point of the WDS at the analysis working distance, then drive the holder to that working distance, select the secondary or back-scattered electron imaging mode and bring the image into focus at fairly high magnification. Then, bring the
unknown specimen under the electron beam and focus the electron image by adjusting the height of the specimen only.

4.4.4 Probe diameter

The probe diameter shall be as small as possible for accurate results while being consistent with the aim of the analysis. The same probe diameter shall be used during the measurement on the reference and the unknown specimen. If necessary, the probe diameter can be enlarged to prevent specimen damage and to reduce contamination.

NOTE The probe diameter and analysis volume are covered in ISO 14594.

As alkali metals such as Na, K, etc., migrate under a focused electron beam, a defocused electron beam should be used for analysis of these elements.

4.4.5 Scanning the focused electron beam

When wishing to analyse an area larger than the normal spot size, either enlarge the spot or use the microscope in the scanning mode. If using the latter, the same procedures for spot analysis shall be considered with the same limitations.

The area analysed should fall within the area of maximum sensitivity of the spectrometer. If the scanning raster is too large, the spectrometer sensitivity will fall off at the extremes of the raster. Thus, spot mode analysis is preferable for high accuracy.

4.4.6 Specimen surface

In quantitative microanalysis, the specimen surface shall be planar and perpendicular to the axis of the electron beam. The specimen shall be polished so that it is as flat and scratch-free as possible. The specimens (reference specimen and unknown specimen) shall be clean and free of dust. The specimen shall be analysed in the unetched condition so as not to alter its topography or surface chemistry.

NOTE It is possible to perform a quantitative analysis on tilted specimens, if the correction model is dedicated to this application and the tilt angle is accurately known.

4.4.7 Selection of X-ray line

In selecting the X-ray line to be used for the analysis, the instructions given hereafter shall be followed:

a) a peak with a high intensity and high P/B ratio shall be chosen;

b) a background shall be selected with which measurement of the continuum is possible;

c) whenever possible, the peak selected should be free of overlapping peaks.

If overlapping peaks cannot be avoided, the following instructions are useful:

— when the overlapping peaks are of higher order, the pulse height analyser should be operated to eliminate these overlaps (for PHA operation, see ISO 17470 and ISO 14594);

— in the event of first-order overlap, a specific programme can be used for peak deconvolution; this procedure can, however, influence the accuracy of the results.[9]

4.4.8 Spectrometer

The spectrometer, the analysing crystal and the detector shall be selected according to the elements and X-ray lines of analytical interest. This shall be done in accordance with the manufacturer's specifications unless extraordinary conditions make following those specifications inappropriate.

The analysing crystal should be selected by making use of data supplied by the instrument manufacturer or from that obtainable from textbooks.